

NEIWEN LING

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RESEARCH INTERESTS

My primary research interests lie at the intersection of Edge Computing, Machine Learning, Cyber-Physical Systems (CPS), and Real-time Systems with a focus on developing **time-sensitive AI systems** for **physical agents**. These systems have wide-ranging applications, including **autonomous driving, robotics, and smart cities**. Additionally, I have extensive experience in developing real-world testbeds, including a campus-scale smart lamppost testbed.

- Systems for Large Language Model (LLM), Time-sensitive LLMs in CPS/IoT
- Concurrent DNN on Edge Platforms, Time-sensitive DNN
- Distributed DNN Systems, Cooperative Edge Computing

RESEARCH EXPERIENCE

Yale University Postdoctoral Associate, Efficient Computing Lab, Department of Computer Science Supervisor: Prof. Lin Zhong Research Directions: Time-sensitive LLM Serving System, System for Embodied AI	10/2023-Present
The Chinese University of Hong Kong Postdoctoral Fellow, AIoT lab, Department of Information Engineering Research Directions: Distributed DL System, Foundation Model for IoT	08/2022-10/2023

EDUCATION

The Chinese University of Hong Kong Ph.D., Information Engineering Supervisor: Prof. Guoliang Xing Research Directions: Concurrent DNN on heterogeneous platforms, Edge Computing	08/2018-07/2022
Northwestern Polytechnical University Bachelor's Degree, Electronics and Information Engineering	09/2014-07/2018

HONORS & AWARDS

• MobiSys Rising Star, ACM MobiSys	2025
• Best Artifact Award Runner-Up, ACM MobiCom	2024
• Best Paper Award Finalist, ACM SenSys	2022
• Best Poster Award, ACM SenSys	2022
• N2Women Young Researcher Fellowship, ACM SenSys	2021
• Postgraduate Scholarship, The Chinese University of Hong Kong	2018-2022
• Undergraduate Excellent Graduation Project, Northwestern Polytechnical University	2018

PUBLICATIONS

Conference/Journal Papers

- Guojun Chen, Xiaojing Yu, Neiwen Ling, and Lin Zhong, "TypeFly: Low-Latency Drone Control with Large Language Models", IEEE Transactions on Mobile Computing, 13 pages double column
IEEE TMC 2025
- Shuyao Shi*, Neiwen Ling(co-primary)*, Zhehao Jiang*, Xuan Huang*, Yuze He, Xiaoguang Zhao, Bufang Yang, Chen Bian, Jingfei Xia, Zhenyu Yan, Raymond Yeung, and Guoliang Xing, "Soar: Design and Deployment of A Smart Roadside Infrastructure System for Autonomous Driving", the 30th Annual International Conference On Mobile Computing And Networking, 16 pages double column
ACM MobiCom 2024, Best Artifact Award Runner-Up

¹* Equal contribution

- Wenjing Xie, Tao Hu, Neiwen Ling, Guoliang Xing, Chun Jason Xue, and Nan Guan, “Timely Fusion of Surround Radar/Lidar for Object Detection in Autonomous Driving Systems”, the 30th IEEE International Conference on Embedded and Real-Time Computing Systems and Application, 6 pages double column
IEEE RTCSA 2024
- Zhehao Jiang*, Neiwen Ling(co-primary)*, Xuan Huang, Shuyao Shi, Chenhao Wu, Xiaoguang Zhao, Zhenyu Yan, and Guoliang Xing, “CoEdge: A Cooperative Edge System for Distributed Real-Time Deep Learning Tasks”, the 22nd ACM/IEEE Conference on Information Processing in Sensor Networks, 14 pages double column
ACM/IEEE IPSN 2023
- Zhihe Zhao, Neiwen Ling, Nan Guan, and Guoliang Xing, “Miriam: Exploiting Elastic Kernels for Real-time Multi-DNN Inference on Edge GPU”, the 21st Conference on Embedded Networked Sensor Systems, 14 pages double column
ACM SenSys 2023
- Bufang Yang, Lixing He, Neiwen Ling, Zhenyu Yan, Guoliang Xing, Xian Shuai, Xiaozhe Ren and Xin Jiang, “EdgeFM: Leveraging Foundation Model for Open-set Learning on the Edge”, the 21st Conference on Embedded Networked Sensor Systems, 14 pages double column
ACM SenSys 2023
- Xiaomin Ouyang, Zhiyuan Xie, Heming Fu, Sitong Cheng, Li Pan, Neiwen Ling, Guoliang Xing, Jiayu Zhou, and Jianwei Huang, “Harmony: Heterogeneous Multi-Modal Federated Learning through Disentangled Model Training”, the 21st ACM International Conference on Mobile Systems, Applications, and Services, 14 pages double column
ACM MobiSys 2023
- Neiwen Ling, Xuan Huang, Zhihe Zhao, Nan Guan, Zhenyu Yan, and Guoliang Xing, “BlastNet: Exploiting Duo-Blocks for Cross-Processor Real-Time DNN Inference”, the 20th Conference on Embedded Networked Sensor Systems, 15 pages double column
ACM SenSys 2022, Best Paper Award Finalist
- Neiwen Ling, Kai Wang, Yuze He, Guoliang Xing, and Daqi Xie, “RT-mDL: Supporting real-time mixed deep learning tasks on edge platforms”, the 19th Conference on Embedded Networked Sensor Systems, 14 pages double column
ACM SenSys 2021
- Zhihe Zhao, Kai Wang, Neiwen Ling, and Guoliang Xing, “Edgectl: An automl framework for real-time deep learning on the edge”, the 6th ACM/IEEE Conference on Internet of Things Design and Implementation, 12 pages double column
ACM/IEEE IoTDI 2021

Selected Preprint

- Neiwen Ling, Guojun Chen, Anurag Khandelwal, and Lin Zhong, “TimelyLLM: Segmented LLM Serving System for Time-Sensitive Robotic Applications”, under review, 15 pages double column
- Neiwen Ling, “Time-Sensitive AI System for Physical Agents”, to appear in the 23rd ACM International Conference on Mobile Systems, ACM MobiSys Rising Star Forum, 2 pages double column

Workshop and Poster/Demo Papers

- Zhihe Zhao, Xian Shuai, Neiwen Ling, Nan Guan, Zhenyu Yan, and Guoliang Xing, “Moses: Exploiting Cross-device Transferable Features for On-device Tensor Program Optimization”, the 24th International Workshop on Mobile Computing Systems and Applications 2023
ACM HotMobile 2023
- Zhihe Zhao, Neiwen Ling, Kaiwei Liu, Nan Guan, and Guoliang Xing, “Unifying On-device Tensor Program Optimization through Large Foundation Model”, the 21st Conference on Embedded Networked Sensor Systems, 2 pages double column
ACM SenSys 2023 Poster
- Zhihe Zhao, Neiwen Ling, Nan Guan, and Guoliang Xing, “Aaron: Compile-time Kernel Adaptation for Multi-DNN Inference Acceleration on Edge GPU”, the 20th Conference on Embedded Networked Sensor Systems
ACM SenSys 2022 Poster, Best Poster Award
- Neiwen Ling*, Yuze He*, Nan Guan, Heming Fu, and Guoliang Xing, “Dataset: An Indoor Smart Traffic Dataset and Data Collection System”, the 5th International SenSys/BuildSys Workshop on Data
ACM DATA 2022, SenSys/BuildSys 2022 Workshop
- Zhihe Zhao, Zhehao Jiang, Neiwen Ling, Xian Shuai, and Guoliang Xing, “Demo Abstract: Ecrt: an edge computing system for real-time image-based object tracking”, the 16th ACM Conference on Embedded Networked Sensor

PROFESSIONAL SERVICES

- **Organizing Committee Member**

- General Co-Chair, International Workshop on Foundation Models for Cyber-Physical Systems & Internet of Things (FMSys'25), in Cyber-Physical Systems and Internet-of-Things Week 2025 (CPS-IoT Week 2025)
- Technical Program Committee Co-Chair, International Workshop on Foundation Models for Cyber-Physical Systems & Internet of Things (FMSys'24), in Cyber-Physical Systems and Internet-of-Things Week 2024 (CPS-IoT Week 2024)
- Organizer, N2Women (Networking Networking Women) Meeting in the 19th ACM Conference on Embedded Networked Sensor Systems (SenSys 2021)

- **Board of Distinguished Reviewers**

- ACM Transactions on Internet of Things (ACM TIIoT 2025-present)

- **Technical Program Committee Member**

- The 23rd ACM Conference on Embedded Networked Sensor Systems (ACM SenSys 2025)
- The 30th International Conference on Parallel and Distributed Systems (IEEE ICPADS 2024)
- Artifact Evaluation, The 30th Annual International Conference on Mobile Computing and Networking (ACM MobiCom 2024)
- The 8th IEEE/ACM Conference on Connected Health: Applications, Systems, and Engineering Technologies (IEEE/ACM CHASE 2023)
- Poster & Demo, The 8th ACM/IEEE International Conference on Internet of Things Design and Implementation 2023 (IEEE/ACM IoTDI 2023)

- **Invited Reviewer**

- IEEE Transactions on Mobile Computing (TMC 2022, 2023, 2024, 2025)
- ACM Transactions on Sensor Networks (TOSN 2023, 2024)
- ACM Transactions on Internet of Things (TIOT 2023, 2024)
- SCIENCE CHINA Information Sciences (SCIS 2023)
- IEEE Network Magazine 2023
- ACM Transactions on Computing for Healthcare (HEALTH 2023)
- IEEE Transactions on Computers 2024
- Proceedings of the ACM on Interactive, Mobile, Wearable and Ubiquitous Technologies (IMWUT/UbiComp 2022)
- IEEE International Conference on Computer Communications (INFOCOM 2024)
- The First Workshop on DL-Hardware Co-Design for AI Acceleration in the 37th AAAI Conference on Artificial Intelligence (DCAA 2023)

REFERENCES

Prof. Lin Zhong

Joseph C. Tsai Professor, ACM Fellow, IEEE Fellow, Yale University, United States

Prof. Guoliang Xing

Professor, ACM Fellow, IEEE Fellow, The Chinese University of Hong Kong, Hong Kong SAR

Prof. Xiaofan (Fred) Jiang

Associate Professor, Columbia University, United States